

Production InP-based MBE HBT Growth And Improvement with Real-Time Monitoring

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IntelliEPI: InP-based Production MBE HBT Development

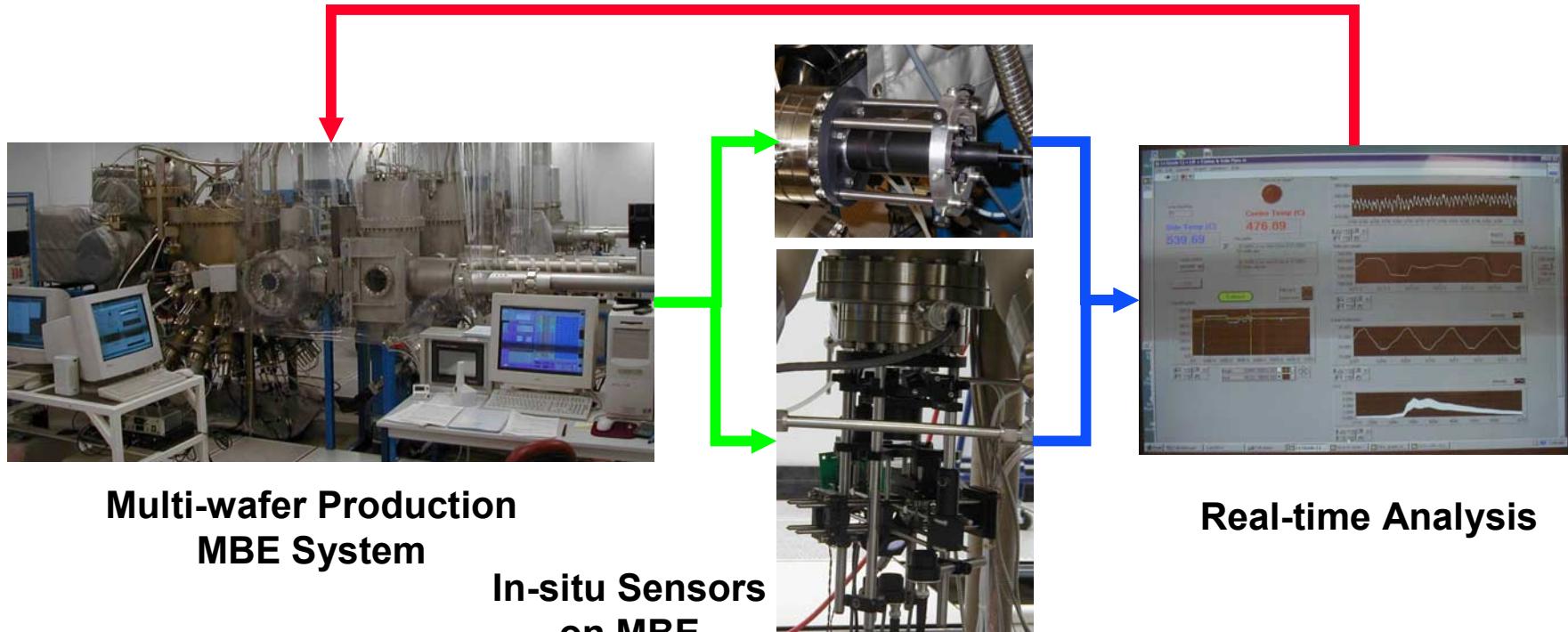
Advantages of MBE for InP-based HBT growth

- *High p-doping to 1E20 cm-3 and high n-doping to 5E19 cm-3*
- *Excellent thickness and interface control*
- *Easy to install various sensors for real-time monitoring*
- *Low background doping*
- *Low safety overhead*

IntelliEPI's Approaches in HBT development

- *Used multi-wafers 4x4in production MBE systems (9x4in)* 12/99
- *Installed sensors to monitor composition, temp., and surface* 01/00
- *Demonstrated reproducible and efficient P-cell operation* 03/00
- *Established safety protocol in P-MBE system R&M* 06/00
- *Delivered volume InP-based structures to customers* 06/00
- *Correlated processing results with in situ data* 12/00
- *Improved epitaxial growth based on correlations* 03/01

IntelliEPI: Sensor-based Production MBE



**Multi-wafer Production
MBE System**

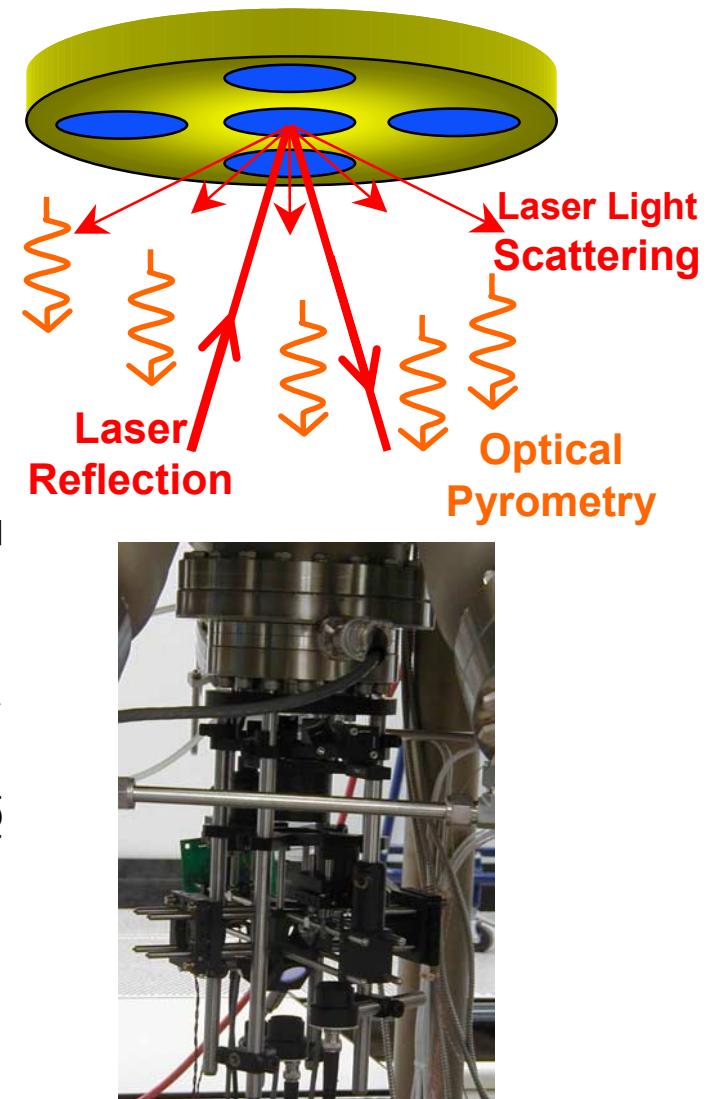
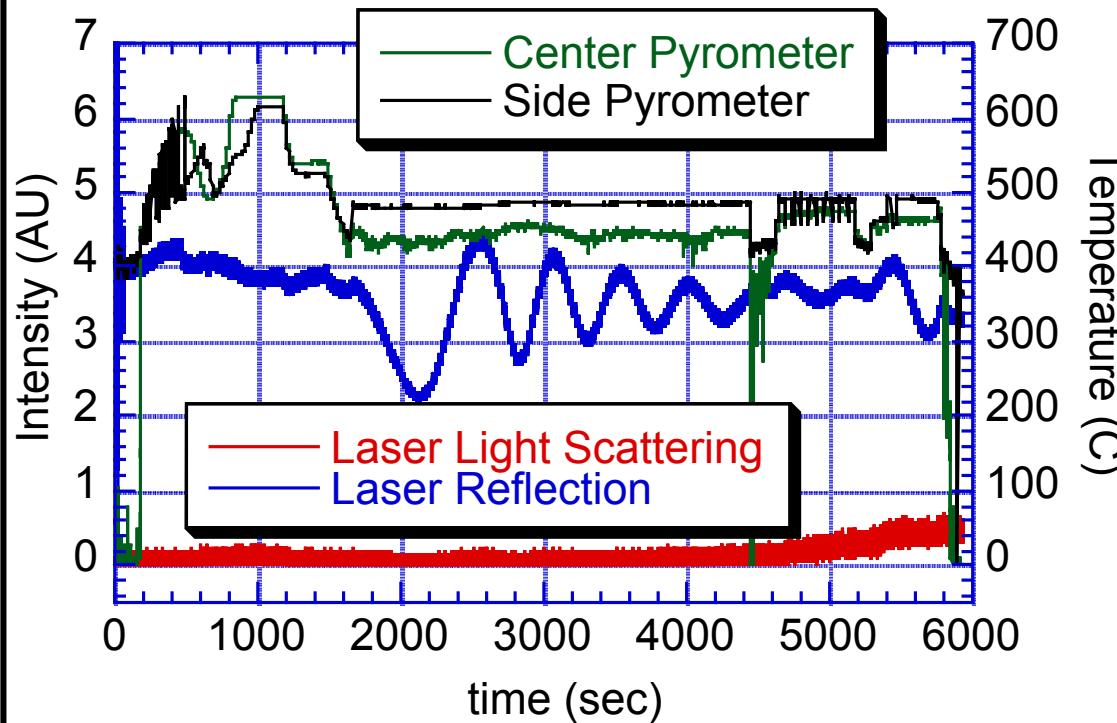
**In-situ Sensors
on MBE**

Real-time Analysis

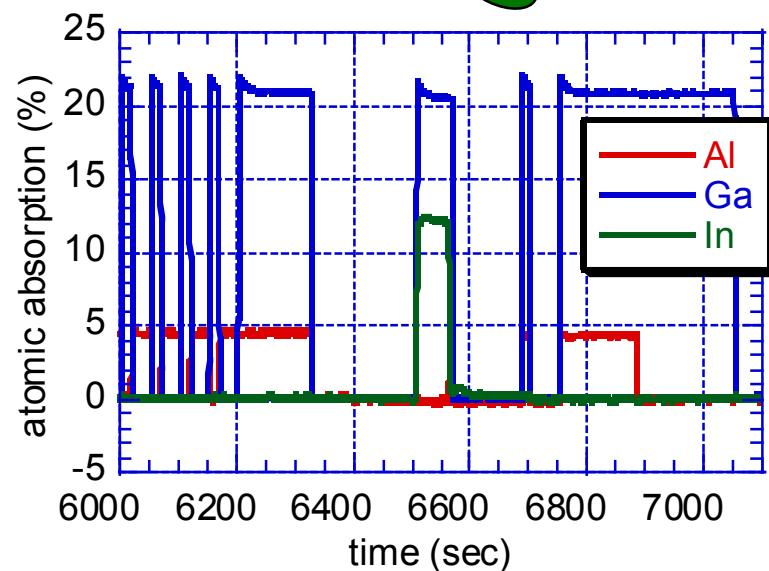
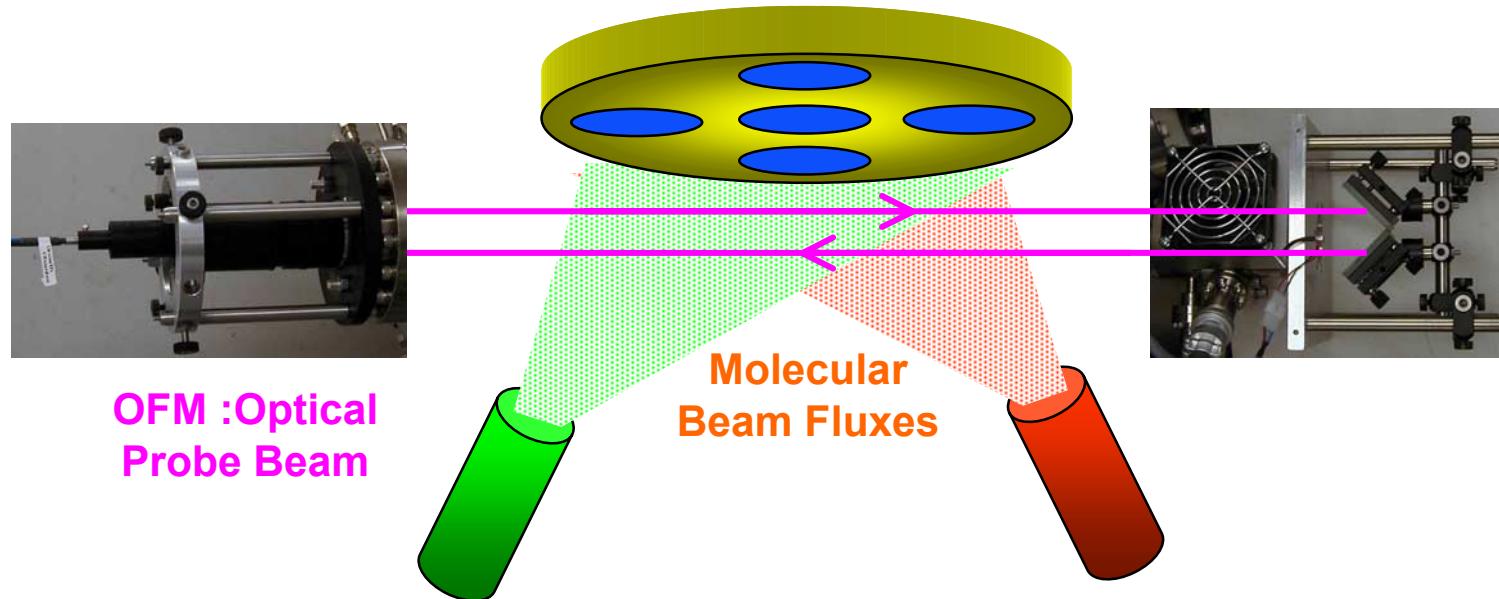
- Real-time monitoring of MBE process using proprietary non-invasive optical measurement techniques
- Rapid product development cycle
- Value-added growth information for customers
- Improve yield

IntelliEPI: Real-time Optical Probes of Substrates

- *Optical Pyrometry and Pyrometric Interferometry*
- *Laser Reflection*
- *Laser Light Scattering*

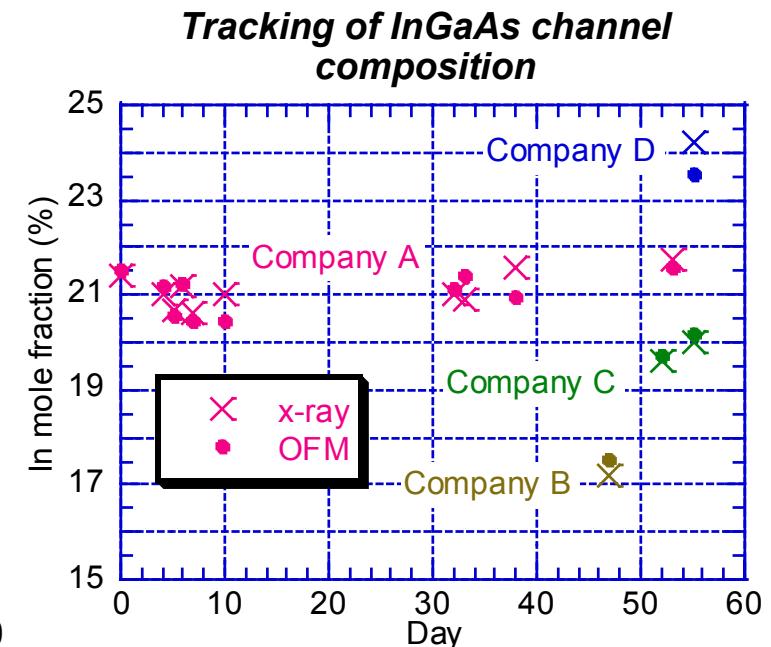
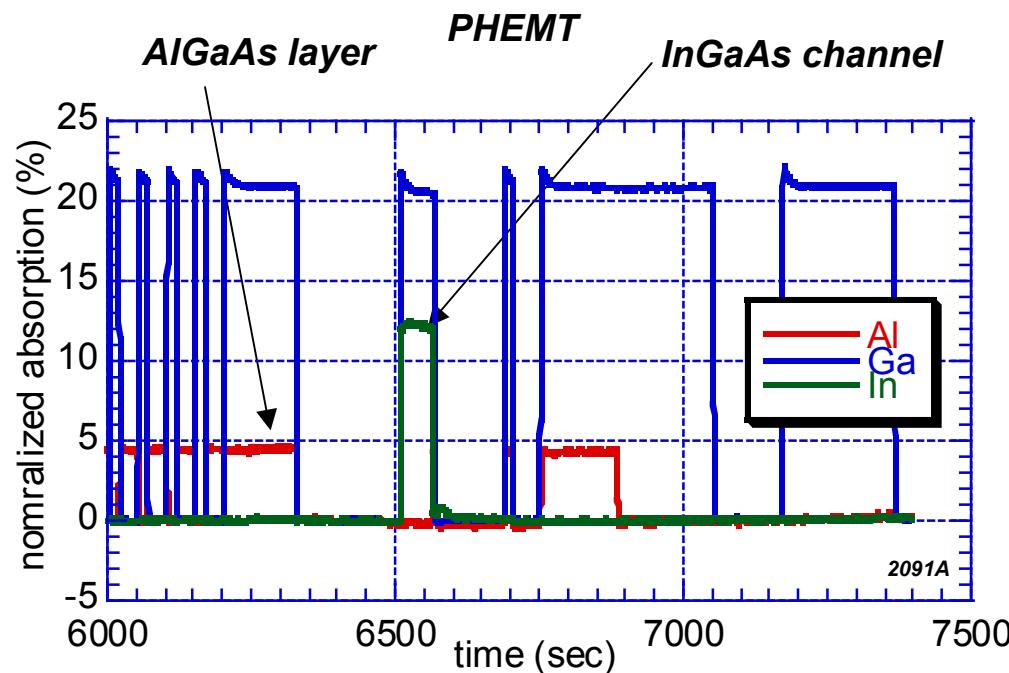


IntelliEPI: Optical-based Flux Monitor (OFM)



- Optically probe atomic absorption of group III fluxes (Al, Ga, and In) simultaneously during growth.
- Continuous real-time measurement of molecular beam flux profile.

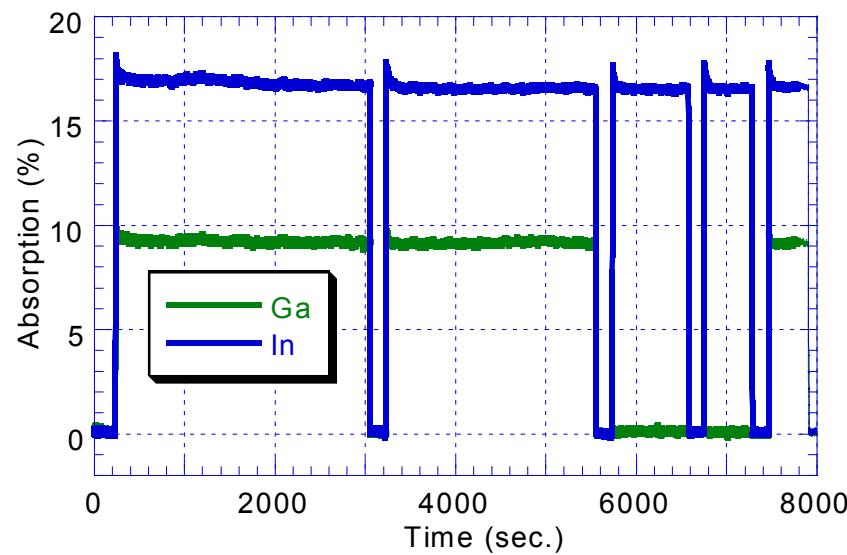
IntelliEPI: OFM Flux Profile for Real-time Analysis



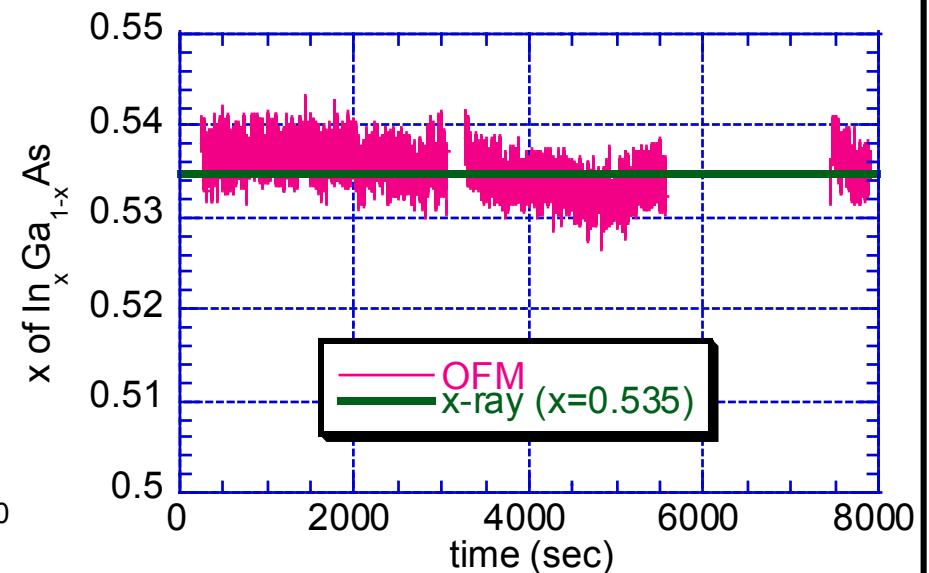
- Determine AlGaAs and InGaAs composition from group III flux ratio.
- Real-time growth rate measurement.
- Quantitative measurement of flux transient.

IntelliEPI: Group III Flux Profile of HBT Growth

OFM flux measured during growth every 0.1 sec.

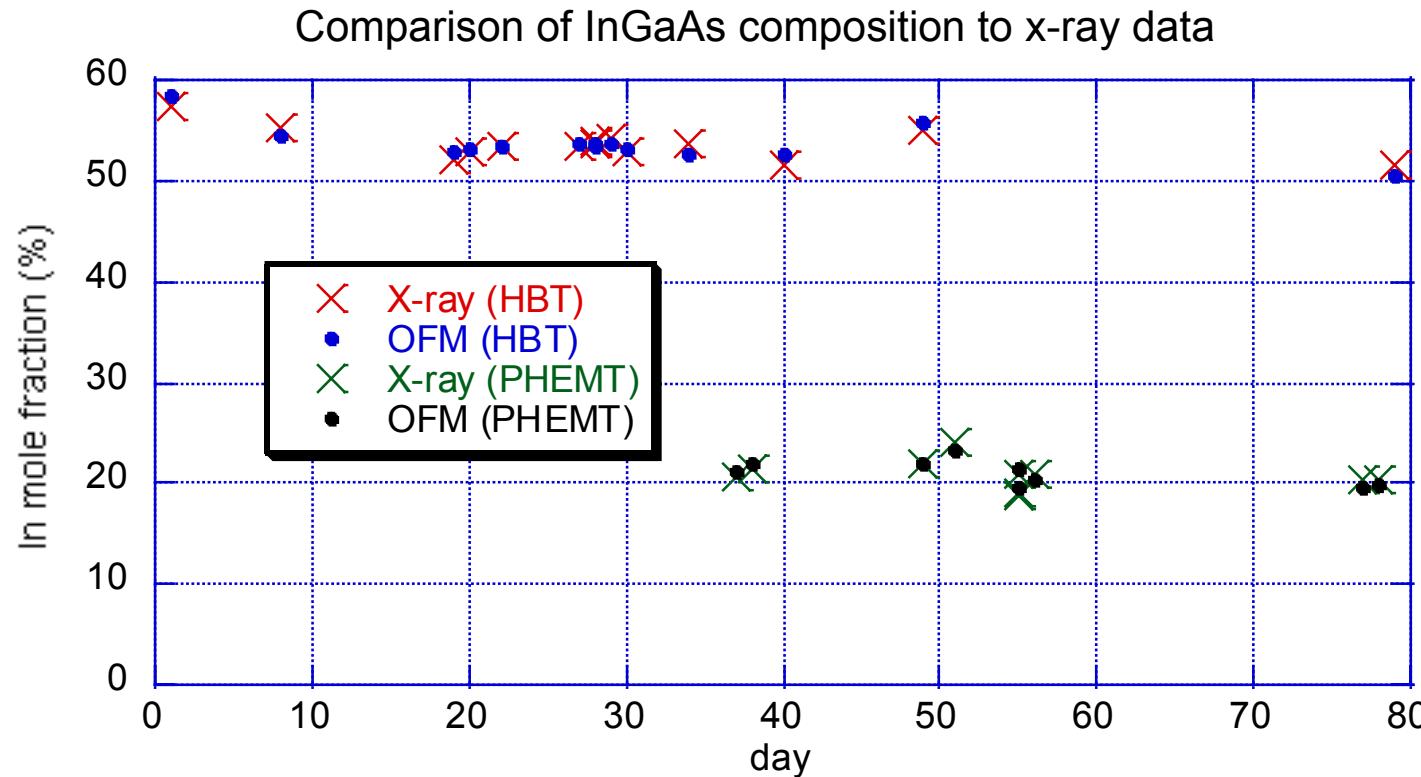


Comparison of InGaAs composition to post growth x-ray analysis.



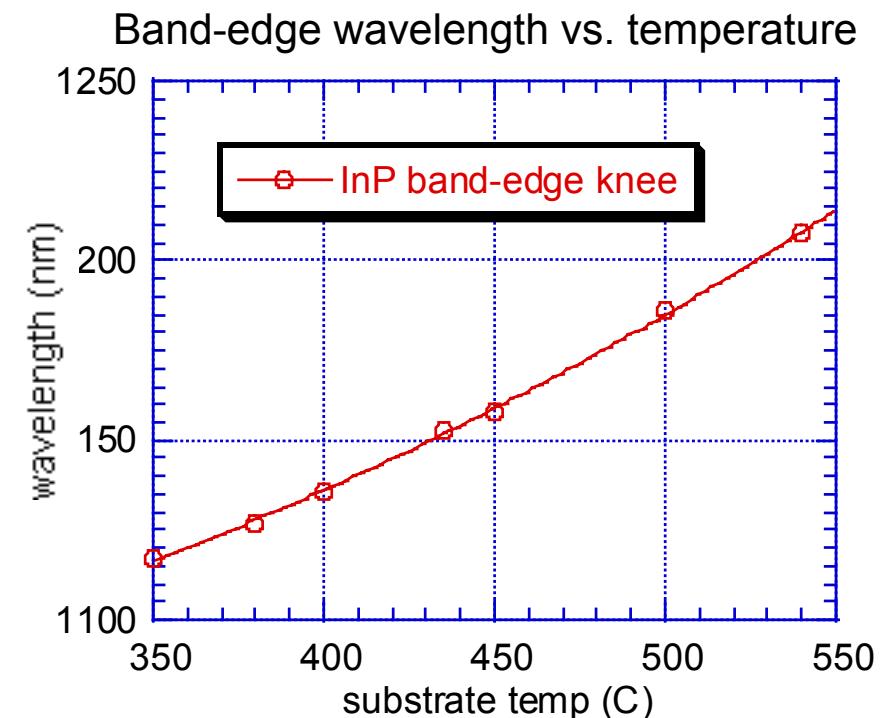
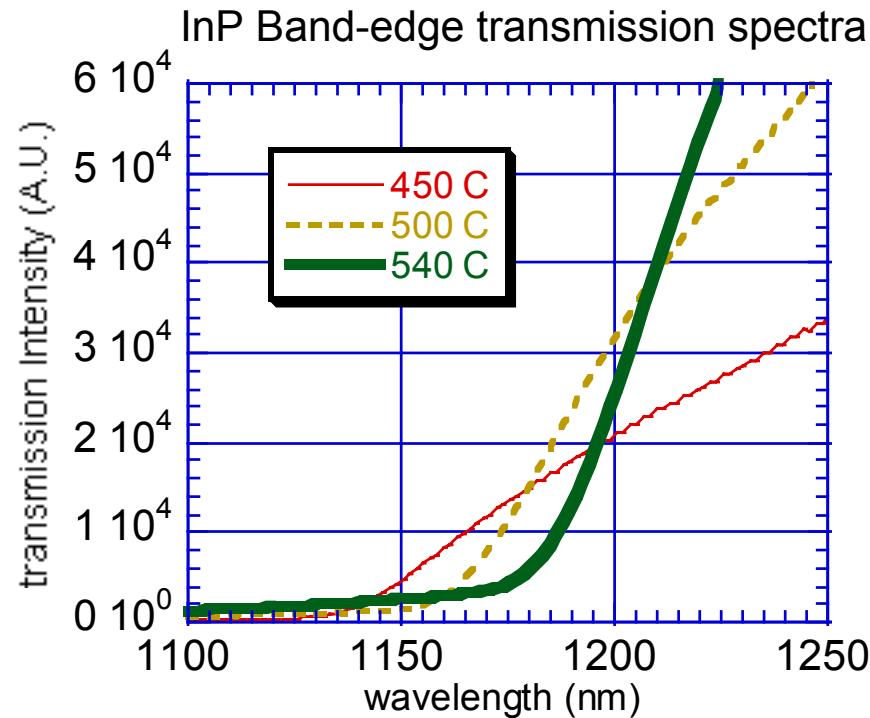
- Real-time monitoring of growth rate and composition.
- InP/InGaAs HBT on InP substrate.

IntelliEPI: InGaAs composition vs. runs



- *OFM real-time monitoring of InGaAs composition during growth.*
- *Compositional accuracy better than ±1%.*

IntelliEPI: Band-edge Temperature Measurement



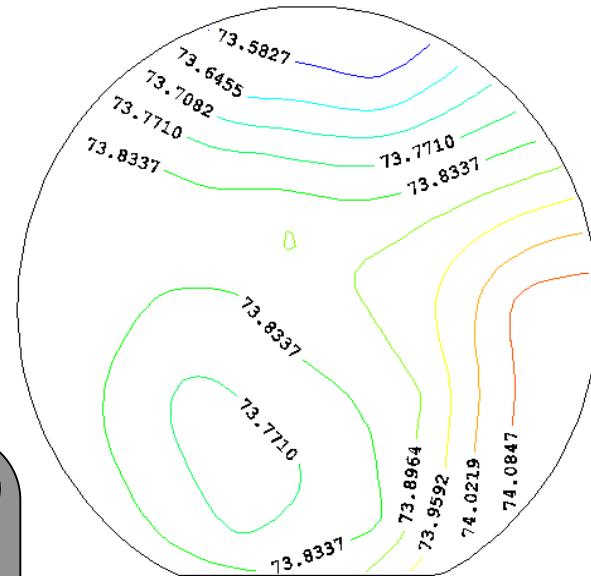
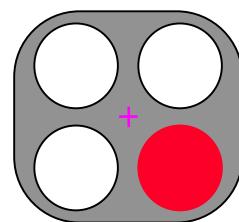
- **Determine substrate temperature by monitoring shift in substrate band gap as a function of temperature.**
- **Measurement range extends to substrate temperature well below the operating range of optical pyrometer.**

IntelliEPI: InP HBTs - Carbon Doping using CBr4

IntelliEPI has successfully developed carbon doping capability using CBr4 gas source

- *Reproducible InGaAs carbon doping up to 1E20 cm-3*
- *Excellent InGaAs material quality (mobility and x-ray FWHM)*
- *No memory effects*
- *Doping sensitive to growth temp and comp.*
- *Across 4in wafer uniformity (<0.2%)*
- *GaAs carbon doping up to 1E20 cm-3*

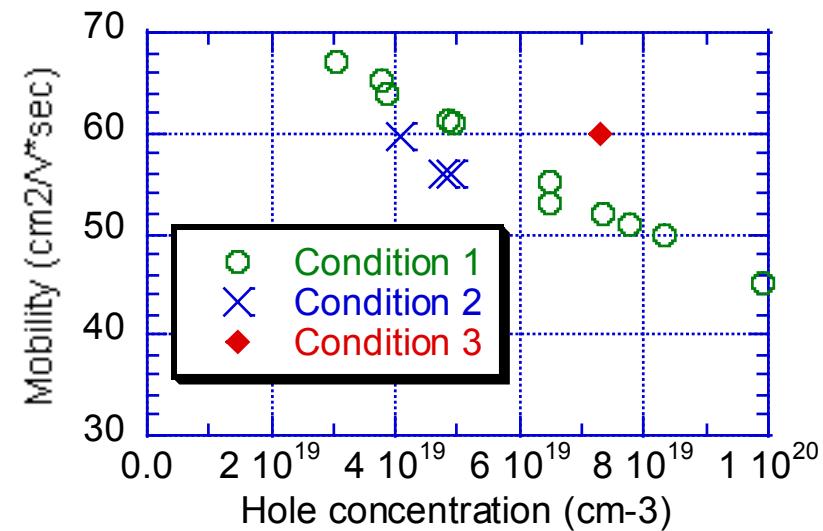
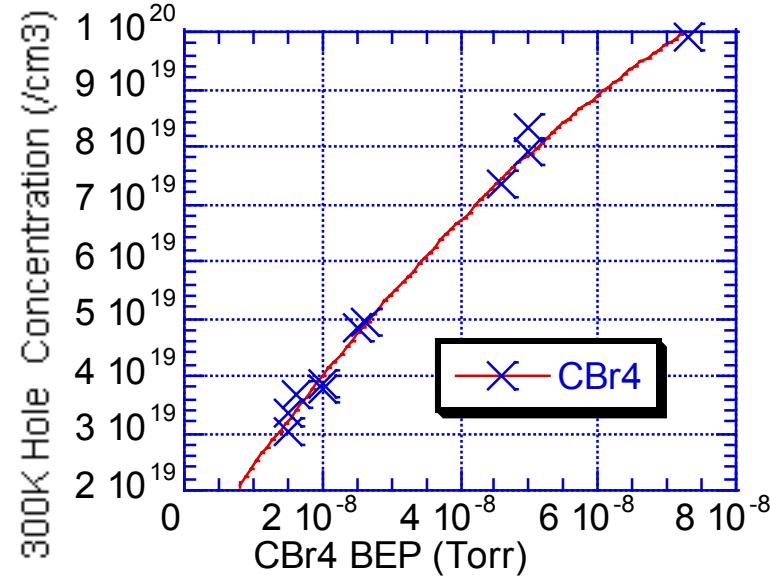
IntelliEPI: CBr₄ Carbon Doping of P-type InGaAs



Statistical Summary

Number of Test Points	36
Average Value	73.8482
Maximum Value	74.1416
Minimum Value	73.521
Sample Spread (%)	0.84
Std Dev Value	0.1379
Wafer Uniformity Value (%)	0.19

Magnetoresistance measurement using Lehighton shows the resistivity across 4" wafer grown from a 4x4 MBE system. The film thickness and the hole mobility is 350 nm and 60 cm²/Vs, respectively.



IntelliEPI: Summary

- Establish monthly production >150 wafers/mo to customers in US, Japan, Korea, Europe, and Taiwan
- Multi-sensor pyrometry/reflectivity: measures growth rate in real-time
- Optical-based Flux Monitor: instantaneous composition measurement of group III fluxes
- Band-edge absorption:
 - Absolute substrate temperature measurement
 - Operate down to low temperature range, critical for InP
- Carbon doping up to 1E20 cm-3 with excellent uniformity
- Excellent uniformity across wafer platen
- All multi-wafer runs; no single wafer runs
- Correlation of processing results and in-situ measurements results is the most powerful tools for IntelliEPI. It will help both IntelliEPI and our customers in yield/production improvements